Appl. No.: 10/539,914

REMARKS

In view of the comments of the examiner in the Advisory Action mailed 05/01/2007, the claims have been amended above to put the term "die-cast" in the body of the independent claims.

As noted in the Response filed 4/12/2007, a "die-cast" member has structural attributes which the housing 20 of Benzoni does Benzoni merely discloses that the housing 20 such as molded comprises a molded non-conductive member; plateable engineering grade plastic (column 2, lines 26-27 and Surfaces of the housing 20 are plated with an electrically conductive material, such as copper (column 3, lines 29-31). A plastic member plated with metal is different from a die-cast member. A die-cast member is more robust than a plastic member having a plated surface. A die-cast member has different electrical conductivity than a plastic member having a plated surface; plastic is electrically insulative. A die-cast member has less resistance to conduct heat than a plastic member having a plated surface. A plastic member is more resistant to heat conduction than a die-cast member. die-cast member can absorb more energy than a plastic member having a plated surface, such as when heating a solder pin; the terminal resistance fuse point is higher for a die cast member.

Favorable reconsideration and allowance is respectfully requested. Should any unresolved issue remain, the examiner is invited to call applicant's attorney at the telephone number indicated below.

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Respectfully submitted,

Mark F. Harrington (Reg. No. 31,686)

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5/9/07

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CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail on the date shown below in an envelope addressed to: Commissioner For Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

May 9, 2007

Name of Person Making Deposit